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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
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10/785,268

02/24/2004

Dong-Hun Lee

8054-46 (AW8136US/MJ

3865

22150

7590

09/30/2005

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EXAMINER

LINDSAY JR, WALTER LEE

ART UNIT

PAPER NUMBER

2812

DATE MAILED: 09/30/2005

Please find below and/or attached an Office communication concerning this application or proceeding.

Office Action Summary

Application No.

10/785,268

Applicant(s)

LEE ET AL.

Examiner

Walter L. Lindsay, Jr.

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-- The MAILING DATE of this communication appears on the cover sheet with the correspondence address --

Period for Reply

A SHORTENED STATUTORY PERIOD FOR REPLY IS SET TO EXPIRE 3 MONTH(S) OR THIRTY (30) DAYS, WHICHEVER IS LONGER, FROM THE MAILING DATE OF THIS COMMUNICATION.

- Extensions of time may be available under the provisions of 37 CFR 1.136(a). In no event, however, may a reply be timely filed after SIX (6) MONTHS from the mailing date of this communication.
- If NO period for reply is specified above, the maximum statutory period will apply and will expire SIX (6) MONTHS from the mailing date of this communication.
- Failure to reply within the set or extended period for reply will, by statute, cause the application to become ABANDONED (35 U.S.C. § 133). Any reply received by the Office later than three months after the mailing date of this communication, even if timely filed, may reduce any earned patent term adjustment. See 37 CFR 1.704(b).

Status

- 1) ☐ Responsive to communication(s) filed on ____.
- 2a) ☐ This action is FINAL. 2b) ☒ This action is non-final.
- 3) ☐ Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under *Ex parte Quayle*, 1935 C.D. 11, 453 O.G. 213.

Disposition of Claims

- 4) ☒ Claim(s) 1-21 is/are pending in the application.
- 4a) Of the above claim(s) ____ is/are withdrawn from consideration.
- 5) ☒ Claim(s) 3 and 12-21 is/are allowed.
- 6) ☒ Claim(s) 1,2,4-7,9 and 11 is/are rejected.
- 7) ☒ Claim(s) 10 is/are objected to.
- 8) ☐ Claim(s) ____ are subject to restriction and/or election requirement.

Application Papers

- 9) ☐ The specification is objected to by the Examiner.
- 10) ☐ The drawing(s) filed on ____ is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.
Applicant may not request that any objection to the drawing(s) be held in abeyance. See 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correction is required if the drawing(s) is objected to. See 37 CFR 1.121(d).
- 11) ☐ The oath or declaration is objected to by the Examiner. Note the attached Office Action or form PTO-152.

Priority under 35 U.S.C. § 119

- 12) ☒ Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).
- a) ☒ All b) ☐ Some * c) ☐ None of:
- 1) ☒ Certified copies of the priority documents have been received.
 - 2) ☐ Certified copies of the priority documents have been received in Application No. ____.
 - 3) ☐ Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)).

* See the attached detailed Office action for a list of the certified copies not received.

Attachment(s)

- | | |
|---|--|
| 1) <input type="checkbox"/> Notice of References Cited (PTO-892) | 4) <input type="checkbox"/> Interview Summary (PTO-413)
Paper No(s)/Mail Date. ____ |
| 2) <input type="checkbox"/> Notice of Draftsperson's Patent Drawing Review (PTO-948) | 5) <input type="checkbox"/> Notice of Informal Patent Application (PTO-152) |
| 3) <input type="checkbox"/> Information Disclosure Statement(s) (PTO-1449 or PTO/SB/08)
Paper No(s)/Mail Date ____ | 6) <input type="checkbox"/> Other: ____ |

DETAILED ACTION

This Office Action is in response to an Amendment filed on 7/11/2005.

Currently, claims 1-7 and 9-21 are pending.

Specification

1. The specification has not been checked to the extent necessary to determine the presence of all possible minor errors. Applicant's cooperation is requested in correcting any errors of which applicant may become aware in the specification.

Claim Rejections - 35 USC § 103

2. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negated by the manner in which the invention was made.

3. The factual inquiries set forth in *Graham v. John Deere Co.*, 383 U.S. 1, 148 USPQ 459 (1966), that are applied for establishing a background for determining obviousness under 35 U.S.C. 103(a) are summarized as follows:

1. Determining the scope and contents of the prior art.
2. Ascertaining the differences between the prior art and the claims at issue.
3. Resolving the level of ordinary skill in the pertinent art.
4. Considering objective evidence present in the application indicating obviousness or nonobviousness.

4. Claims 1, 2, 4-7, 9 and 11 are rejected under 35 U.S.C. 103(a) as being unpatentable over Lee et al. (U.S. Patent No. 5,872,047 dated 2/16/1999).

Lee shows the method as claimed in Figs. 2A-2D and corresponding text as:
forming an N type gate pattern and a P type gate pattern on an N type transistor area

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(13) and a P type transistor area (15), respectively, of a semiconductor substrate (11) (Fig. 2A) (col. 3, lines 35-48); selectively implanting N type impurities (25) into the N type transistor area (col. 3, lines 35-48); forming an insulation layer (27) on the substrate including the N type gate pattern and the P type gate pattern (col. 3, lines 49-65); forming a first spacer (27) on sidewalls of the P type gate pattern by anisotropically etching a portion of the insulation layer in the P type transistor area while a portion of the insulation layer (29) remains in the N type transistor area (col. 3, lines 49-65); and selectively implanting P type impurities (40B) into the P type gate pattern including the first spacer and into the P type transistor area (col. 4, lines 11-30) (claim 1). Lee teaches that the N type gate pattern and the P type gate pattern include a gate oxide layer pattern (19) and an undoped polysilicon layer pattern (21) (col. 3, lines 35-48) (claim 2). Lee teaches that a photoresist pattern (23) is formed on the substrate to selectively expose the N type transistor area; forming an N type impurity region having a low impurity concentration and an N type conductive gate pattern by implanting the N type impurities into the N type gate pattern and into the N type transistor area using the photoresist pattern as a mask (col. 3, lines 35-48); and removing the photoresist (col. 3, lines 49-65) (claim 4). Lee teaches that a photoresist pattern is formed on the substrate to selectively expose the P type transistor area, wherein forming the first spacer on the sidewall of the P type gate pattern by anisotropically etching the portion of the insulation layer in the P type transistor area includes using the photoresist pattern as an etching mask (col. 3, lines 35-48) (claim 9). Lee teaches that the N type impurities include

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arsenic (As) (25)(col. 3, lines 35-48)(claim 5). Lee teaches that the P type impurities (40B) include boron (B) (col. 4, lines 7-10) (claim 11).

Lee lacks the anticipation only in not explicitly teaching that: 1) the insulation layer has a thickness of about 160 to about 240Å (claim 1); 2) the insulation layer includes silicon nitride (claim 6) and 3) the insulation layer is formed at a temperature of about 700 to about 800°C (claim 7).

Given the teaching of the references, it would have been obvious to determine the optimum thickness, temperature as well as condition of delivery of the layers involved. See *In re Aller*, Lacey and Hall (10 USPQ 233-237) It is not inventive to discover optimum or workable ranges by routine experimentation. Note that the specification contains no disclosure of either the critical nature of the claimed ranges or any unexpected results arising therefrom. Where patentability is said to be based upon particular chosen dimensions or upon another variable recited in a claim, the Applicant must show that the chosen dimensions are critical. *In re Woodruff*, 919 f.2d 1575,1578, 16 USPQ2d 1934, 1936 (Fed. Cir. 1990).

It would be obvious to one of ordinary skill in the art at the time the invention was made, to modify Lee by optimizing the insulation layer and the temperature of forming.

Allowable Subject Matter

5. Claim 10 is objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

6. Claims 3, 12-15 and 16-21 are allowed.

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7. The following is a statement of reasons for the indication of allowable subject matter: the prior art, either singly or in combination fails to anticipate or render obvious, the limitations of:

...forming an oxide layer on the substrate including the N type gate pattern and the P type gate pattern to repair damage to the substrate and the gate patterns after forming the N type gate pattern and the P type gate pattern, as required by claim 3;

...selectively removing the portion of the insulation layer in the N type transistor region and selectively removing the first spacer on the P type transistor region, as required by claim 12; and

...forming a thermal oxidized layer on the substrate including the gate patterns to repair damage to the substrate and the gate patterns;

selectively implanting N type impurities into the N type gate patterns and into a portion of the substrate adjacent to the N type gate pattern to change the undoped polysilicon layer pattern into a conductive polysilicon layer and to form an N type impurity region having a low impurity concentration adjacent to the N type gate pattern; and

forming an insulation layer on the substrate including the gate patterns, as required by claim 16.

Conclusion

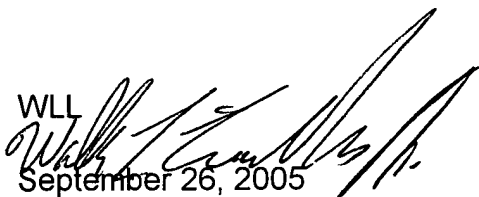
Any inquiry concerning this communication or earlier communications from the examiner should be directed to Walter L. Lindsay, Jr. whose telephone number is (571) 272-1674. The examiner can normally be reached on Monday-Thursday.

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael S. Lebentritt can be reached on (571) 272-1873. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see <http://pair-direct.uspto.gov>. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free).

Walter L. Lindsay, Jr.
Examiner
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WLL

September 26, 2005